## Formation of WB<sub>4</sub> thin films using nanosecond Nd-YAG laser

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In many manufacturing processes, materials must be cut, formed, or drilled, and their surfaces protected with wear-resistant coatings. For mentioned application tungsten tetraboride WB<sub>4</sub> is one of the most promising candidates for the ultra-incompressible, super-hard and inexpensive material [1-3]. Even in the form of thin films it has superhard properties [4] and in the future may be an alternative to other hard coatings for example diamond-like DLC or cubic boron nitride (c-BN). One of the most promising methods of obtaining WB<sub>4</sub> films is pulsed laser deposition (PLD) because it suits very well for deposition of hardly meltable materials as W and B. The beam intensity of a conventional Nd:YAG laser at the focal spot on the target is easily in the range of GW/cm<sup>2</sup>, which means that the laser can evaporate any known material. One of the usually mentioned advantages of this method is that stoichiometry is preserved. WB<sub>4</sub> films have been deposited on Si (100), by PLD technique using nanosecond, Nd:YAG laser working at 355 nm (54000 laser pulses at 10 Hz repetition). The laser fluence was about 6 J/cm<sup>2</sup> and the substrate temperature was 570°C. Additionally the surface of SPS sintered WB<sub>x</sub> target before and after ablation process was examined. WB2 to WB4 phase change at the surface of target is observed. The phase analysis, crystallography and orientations have been studied using X-ray diffractometry. The surface layer after ablation and deposition film are found to be mostly crystalline WB<sub>4</sub> (Fig.1). The surface topography and chemical composition have been measured using scanning profilometer, SEM and EDS respectively. The profilometer measurements show about 1 µm thickness of deposited films (Fig.2). The deposited film (Fig.2,3) and surface layer after ablation are rugged. The SEM with EDS measurements indicated that both films have stoichiometric composition similar to theoretical. The micro indentation test indicate that both films are very hard  $H_v > 30$ GPa (Fig.4).

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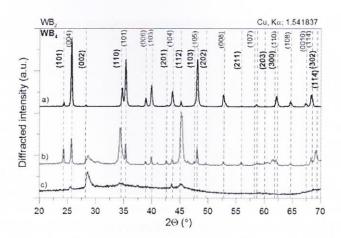


Fig. 1: X-ray diffraction pattern of (a) target; (b) target surface layer after ablation, (c) deposited film

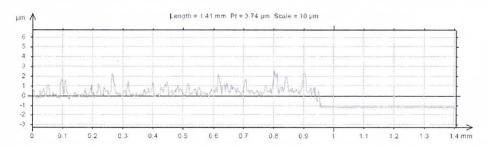


Fig. 2: The profile of surface of deposited WB<sub>4</sub> film.



Fig. 3: SEM micrograph of WB4 film after deposition (magnification  $\times 5000$ )

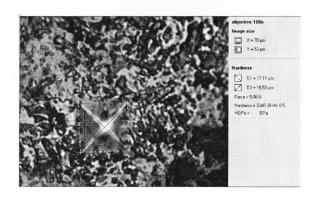


Fig. 4: Vickers microhardness of  $\mathrm{WB}_x$  target (force 5N,  $\mathrm{H}_v{=}32{,}75~\mathrm{GPa}$  )